FAIRCHILD

SEMICONDUCTOR

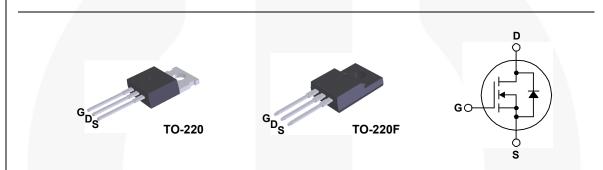
FQP4N90C / FQPF4N90C **N-Channel QFET® MOSFET** 900 V, 4.0 A, 4.2 Ω

Description

This N-Channel enhancement mode power MOSFET is • 4.0 A, 900 V, R_{DS(on)} = 4.2 Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 17 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 5.6 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- $I_{D} = 2.0 \text{ A}$



Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

| Symbol | Parameter | FQP4N90C | FQPF4N90C | Unit | |
|--|---|-------------|-----------|-------|------|
| V _{DSS} | Drain-Source Voltage | | 9 | V | |
| I _D | Drain Current - Continuous ($T_C = 25^{\circ}C$) | | 4 | 4 * | А |
| | - Continuous (T _C = 100°C) | _ | 2.3 | 2.3 * | А |
| I _{DM} | Drain Current - Pulsed | (Note 1) | 16 | 16 * | А |
| V _{GSS} | Gate-Source Voltage | | ± | V | |
| E _{AS} | Single Pulsed Avalanche Energy | (Note 2) | 570 | | mJ |
| I _{AR} | Avalanche Current | (Note 1) | 4 | | Α |
| E _{AR} | Repetitive Avalanche Energy | (Note 1) | 14 | | mJ |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | 4.5 | | V/ns |
| P _D Power Dissipation ($T_C = 25^{\circ}C$) | | | 140 | 47 | W |
| | - Derate above 25°C | | 1.12 | 0.38 | W/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | -55 to +150 | | °C | |
| TL | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds. | | 3 | °C | |

* Drain current limited by maximum junction temperature.

Thermal Characteristics

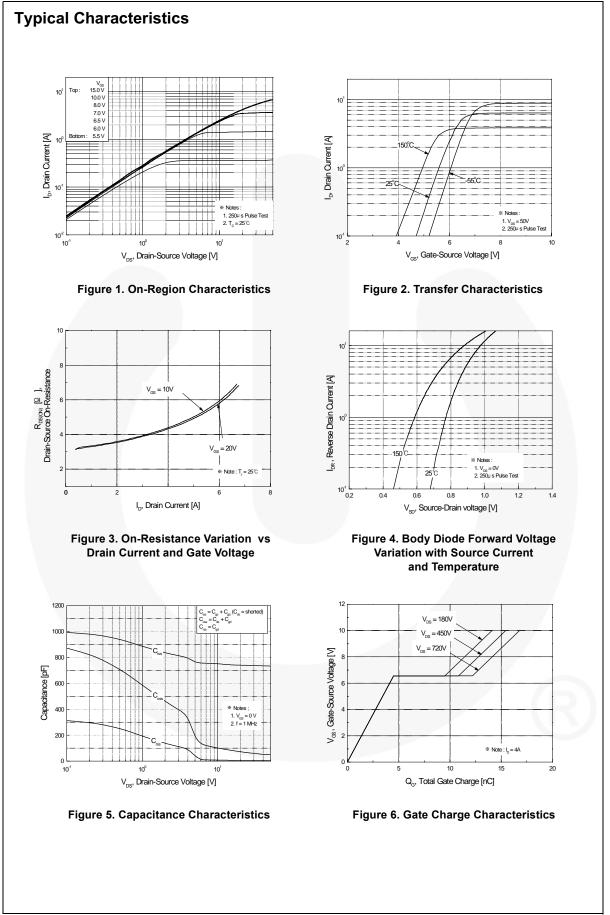
| Symbol | Parameter | FQP9N90C | FQPF9N90CT | Unit | |
|-----------------|---|----------|------------|------|--|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case, Max. | 0.89 | 2.66 | °C/W | |
| $R_{\theta CS}$ | Thermal Resistance, Case-to-Sink Typ, Max. | 0.5 | | °C/W | |
| R_{\thetaJA} | Thermal Resistance, Junction-to-Ambient, Max. | 62.5 | 62.5 | °C/W | |

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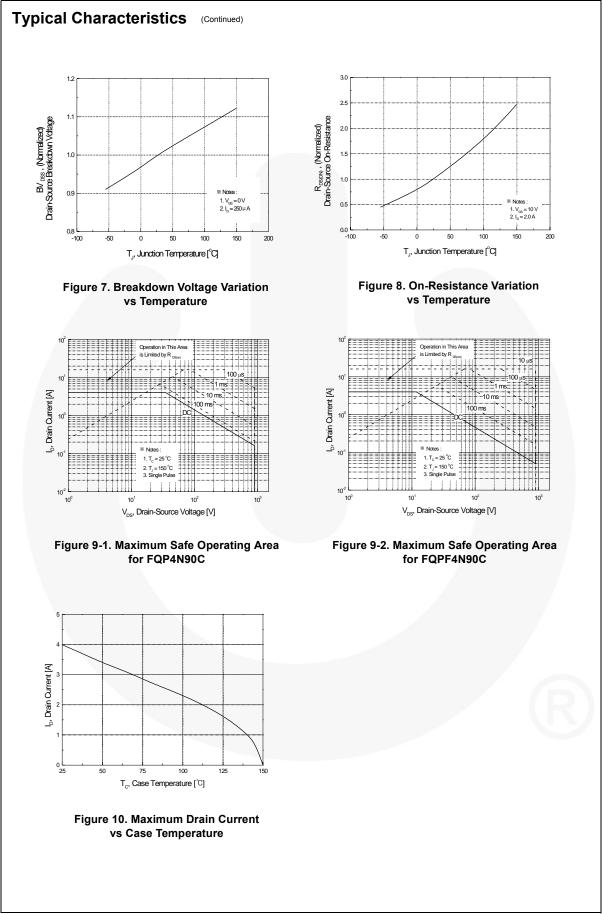
| FQP4N90C FQP4N90C TO | | Top Mark | rk Pac | | kage Packing Method Ree | | Size | Tape Width | | Quantity | |
|------------------------------------|--------------------------|---------------------------------------|--|---|------------------------------|----------|------|------------|------|----------|--|
| | | FQP4N90C | TO- | 220 | Tube | N/. | A | N/A | | 50 units | |
| | | TO-2 | 220F Tube N/ | | /A N// | | | 50 units | | | |
| Electric | cal Cha | racteristics | T _C = 25°0 | C unless ot | herwise noted. | | | | | | |
| Symbol | | Parameter | | | Test Conditions | | Min. | Тур. | Max. | Unit | |
| Off Cha | racterist | ics | | | | | | | | | |
| BV _{DSS} | Drain-Sou | rce Breakdown Volta | ige | V _{GS} = | 0 V, I _D = 250 μA | | 900 | | | V | |
| ΔBV_{DSS} / ΔT_{J} | Breakdow Coefficient | n Voltage Temperatu t | turo | | 50 μA, Referenced to 25°C | | | 1.05 | | V/°C | |
| I _{DSS} | Zoro Coto | Voltago Droin Curro | $V_{DS} = 900 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | | 10 | μA | | | |
| | Zeio Gale | Voltage Drain Curre | ant - | $V_{DS} = 720 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$ | | | | | 100 | μA | |
| I _{GSSF} | Gate-Body | / Leakage Current, F | orward | $V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$ | | | | | 100 | nA | |
| I _{GSSR} | Gate-Body | / Leakage Current, F | Reverse | $V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ | | | | -100 | nA | | |
| On Cha | racterist | ics | | | | | | | | | |
| V _{GS(th)} | Gate Thre | shold Voltage | | $V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$ | | 3.0 | | 5.0 | V | | |
| R _{DS(on)} | Static Drai On-Resist | | | V _{GS} = | 10 V, I _D = 2 A | | | 3.5 | 4.2 | Ω | |
| 9 _{FS} | Forward T | ransconductance | | $V_{DS} =$ | 50 V, I _D = 2 A | | | 5 | | S | |
| Dynami | ic Charac | teristics | | | | | | | | | |
| C _{iss} | Input Capa | acitance | | V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz | | | 740 | 960 | pF | | |
| C _{oss} | Output Ca | pacitance | | | | | 65 | 85 | pF | | |
| C _{rss} | Reverse T | ransfer Capacitance | | | | | 5.6 | 7.3 | pF | | |
| Switchi | ng Chara | acteristics | | | | | | | | | |
| t _{d(on)} | Turn-On D | | _ | | 450.1/1 4.4 | | | 25 | 60 | ns | |
| t _r | Turn-On R | | - | $V_{DD} = 450 \text{ V}, \text{ I}_{D} = 4 \text{ A},$ | | | 50 | 110 | ns | | |
| t _{d(off)} | Turn-Off D | elay Time | | | R _G = 25 Ω | | | 40 | 90 | ns | |
| t _f | Turn-Off F | all Time | | | | (Note 4) | | 35 | 80 | ns | |
| Qg | Total Gate | Charge | | Vne = | 720 V, I _D = 4 A, | | | 17 | 22 | nC | |
| Q _{gs} | Gate-Sour | ce Charge | | $V_{\rm GS} = 120$ V, $I_{\rm D} = 4$ A, $V_{\rm GS} = 10$ V | | / | 4.5 | | nC | | |
| Q _{gd} | Gate-Drain Charge | | | (Note 4) | | | | 7.5 | | nC | |
| | I | | stice c | ad Mar | vimum Potinco | | | | | | |
| I _S | 1 | ode Characteris Continuous Drain-S | | | | | | | 4 | Α | |
| I _{SM} | Maximum | Pulsed Drain-Source | e Diode F | orward | Current | | | | 16 | Α | |
| V _{SD} | | rce Diode Forward V | | | 0 V, I _S = 4 A | | | | 1.4 | V | |
| t _{rr} | | ecovery Time | 5 | | 0 V, I _S = 4 A, | | | 450 | | ns | |
| Q _{rr} | Reverse Recovery Charge | | | $dI_{\rm F} / dt = 100 \text{ A}/\mu \text{s}$ | | | | 3.5 | | μC | |

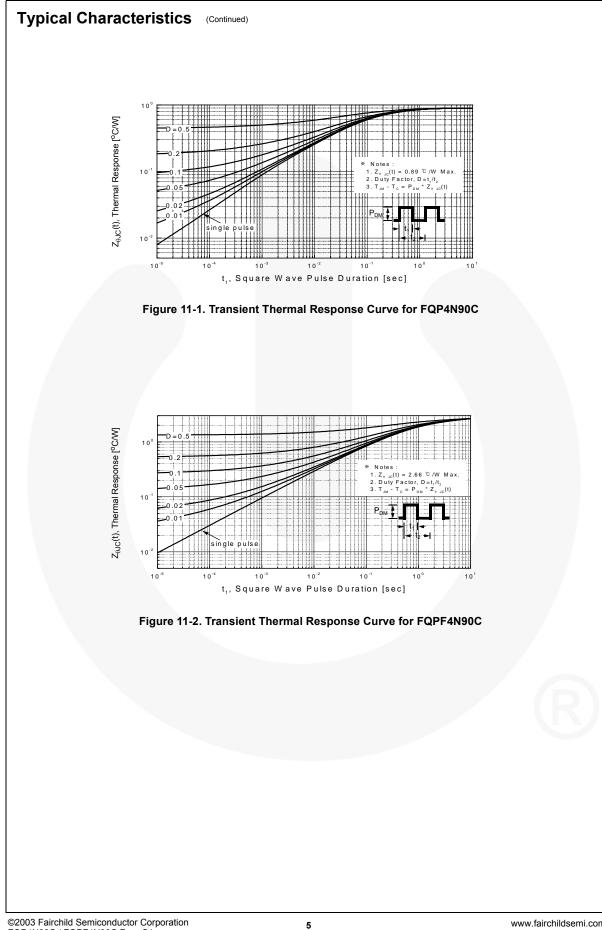
Notes: 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 67 mH, I_{AS} = 4 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} ≤ 4 A, di/dt ≤ 200 A/µs, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature.

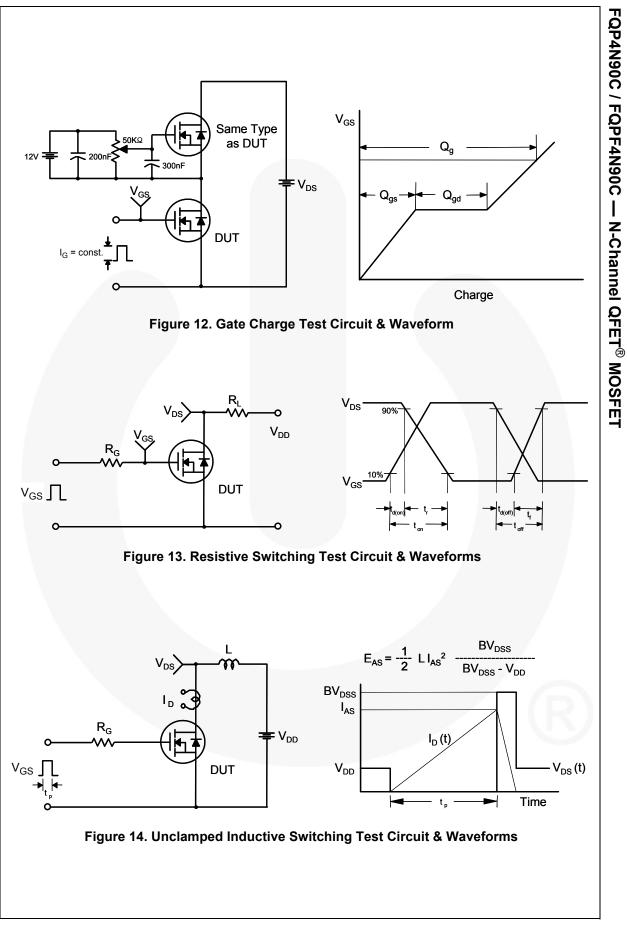
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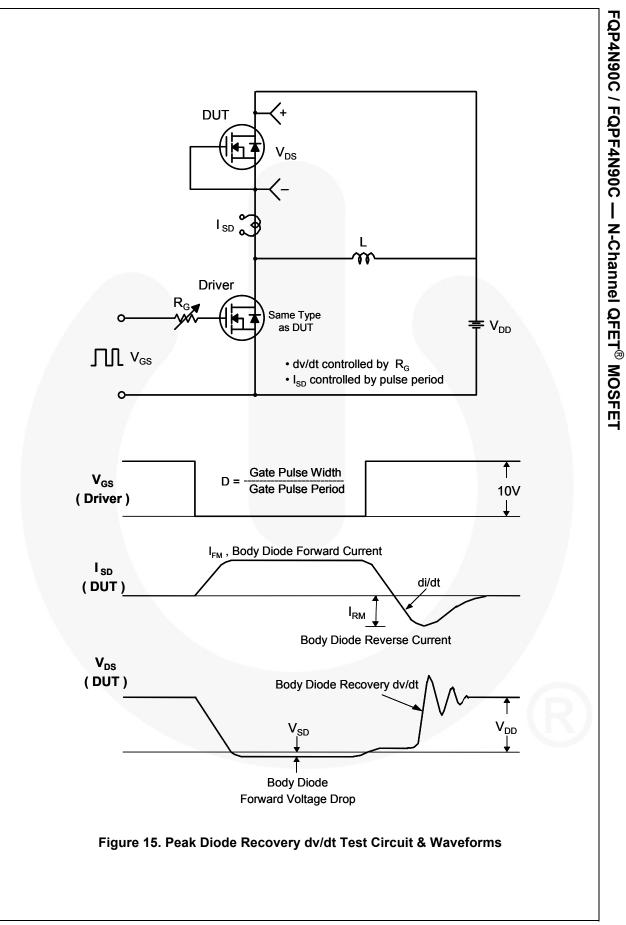


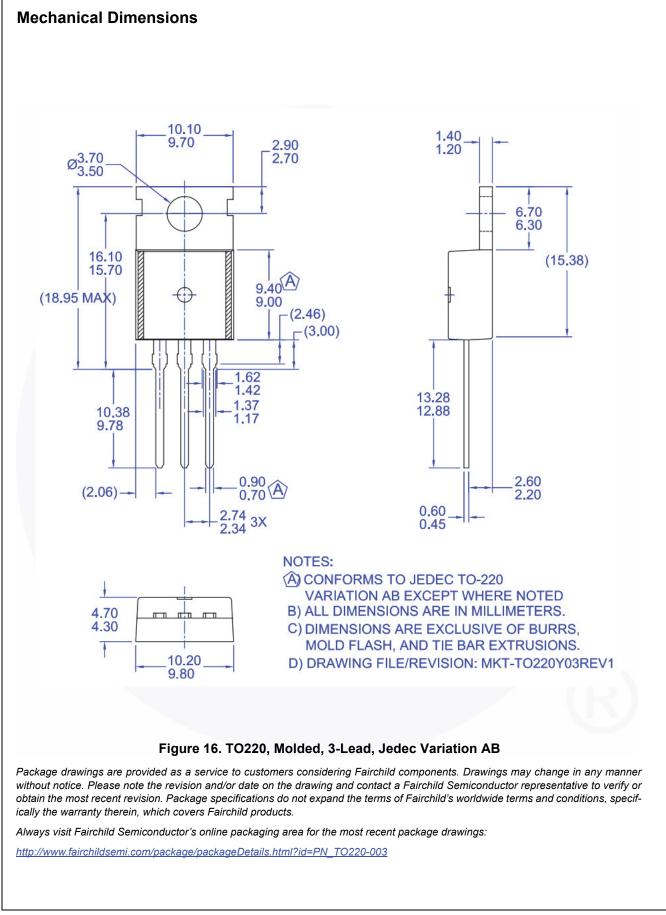
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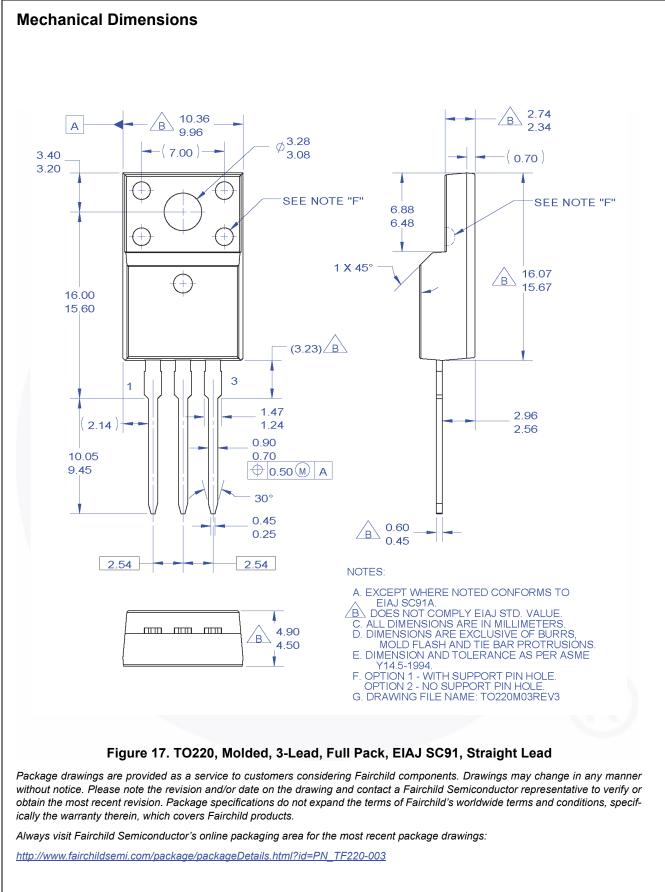












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| Advance Information | Formative / In Design | Datasneet contains the design specifications for product development. Specifications may change in any manner without notice. |
|--------------------------|-----------------------|---|
| Preliminary | First Production | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |
| No Identification Needed | Full Production | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design. |
| Obsolete | Not In Production | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only. |
| | | Rev. 166 |